International TOR Rectifier

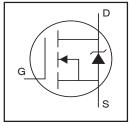
AUTOMOTIVE GRADE

AUIRFR2405

HEXFET® Power MOSFET

Features

- Advanced Planar Technology
- Dynamic dV/dT Rating
- Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified*



$V_{(BR)DSS}$	55V
R _{DS(on)} typ.	11.8m Ω
max	16m Ω
I _{D (Silicon Limited)}	56A ⑥
I _{D (Package Limited)}	30A

Description

Specifically designed for Automotive applications, this Stripe Planar design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is $25^{\circ}C$, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	56®	
I _D @ T _C = 100°C	Continuous Drain Current, VGS @ 10V (Silicon Limited)	40⑥	Α
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Package Limited)	30	
I _{DM}	Pulsed Drain Current ①	220	
P _D @T _C = 25°C	Power Dissipation	110	W
	Linear Derating Factor	0.71	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ^②	130	mJ
I _{AR}	Avalanche Current ①	34	Α
E _{AR}	Repetitive Avalanche Energy ①	11	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns
T_{J}	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ®		1.4	
$R_{\theta JA}$	Junction-to-Ambient (PCB Mount) ^⑦		50	°C/W
$R_{\theta JA}$	Junction-to-Ambient		110	

HEXFET® is a registered trademark of International Rectifier.

^{*}Qualification standards can be found at http://www.irf.com/

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.052		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		11.8	16	mΩ	V _{GS} = 10V, I _D = 34A ④
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
gfs	Forward Transconductance	30			S	V _{DS} = 25V, I _D = 34A [⊕]
I _{DSS}	Drain-to-Source Leakage Current			20	μΑ	$V_{DS} = 55V$, $V_{GS} = 0V$
				250		$V_{DS} = 44V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			200	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-200		$V_{GS} = -20V$

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge	 	70	110		$I_D = 34A$
Q _{gs}	Gate-to-Source Charge		16	23	nC	$V_{DS} = 44V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		19	29	1	V _{GS} = 10V ⊕
t _{d(on)}	Turn-On Delay Time		15			$V_{DD} = 28V$
t _r	Rise Time		130		1	$I_D = 34A$
t _{d(off)}	Turn-Off Delay Time		55		ns	$R_G = 6.8\Omega$
t _f	Fall Time		78		1	$R_D = 10\Omega \ \oplus$
L _D	Internal Drain Inductance		4.5			Between lead,
					nΗ	6mm (0.25in.)
L _S	Internal Source Inductance		7.5		Ī	from package
						and center of die contact
C _{iss}	Input Capacitance		2430			$V_{GS} = 0V$
Coss	Output Capacitance		470		рF	$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		100			f = 1.0MHz, See Fig. 5
Coss	Output Capacitance		2040			$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
Coss	Output Capacitance		350		1	$V_{GS} = 0V, V_{DS} = 44V, f = 1.0MHz$
C _{oss} eff.	Effective Output Capacitance (5)		350		1	$V_{GS} = 0V$, $V_{DS} = 0V$ to 44V

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			56®		MOSFET symbol
	(Body Diode)				Α	showing the
I _{SM}	Pulsed Source Current		_	220		integral reverse
	(Body Diode) ①					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C, I_S = 34A, V_{GS} = 0V $ ④
t _{rr}	Reverse Recovery Time		62	93	ns	$T_J = 25^{\circ}C, I_F = 34A$
Q _{rr}	Reverse Recovery Charge		170	260	nC	di/dt = 100A/μs ④
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

- Repetitive rating; pulse width limited by max. junction temperature.
- $\label{eq:starting} \begin{array}{ll} \text{ Starting T}_J = 25^{\circ}\text{C}, \ L = 0.22\text{mH} \\ \text{R}_G = 25\Omega, \ \text{I}_{AS} = 34\text{A}. \end{array}$
- $\label{eq:loss} \begin{array}{l} \text{ } 3 \text{ } I_{SD} \leq 34A, \text{ di/dt} \leq 190A/\mu s, \text{ } V_{DD} \leq V_{(BR)DSS}, \\ T_{J} \leq 175^{\circ}\text{C}. \end{array}$

- © Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 30A.
- ② When mounted on 1" square PCB (FR-4 or G-10 Material) . For recommended footprint and soldering techniques refer to application note #AN-994.
- \otimes R_{θ} is measured at T_J of approximately 90°C.

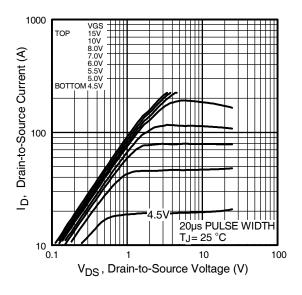
Qualification Information[†]

		Automotive			
		(per AEC-Q101) ^{††}			
Qualification	n Level	Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
Moisture Ser	nsitivity Level	el D-Pak MSL1			
	Machine Model	Class M4 (+/- 500V) ^{†††}			
		AEC-Q101-002			
ESD	Human Body Model	Class H1C (+/- 2000V) ^{†††}			
ESD		AEC-Q101-001			
	Charged Device	Class C5 (+/- 2000V) ^{†††}			
	Model		AEC-Q101-005		
RoHS Comp	liant	Yes			

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

^{††} Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.

^{†††} Highest passing voltage.



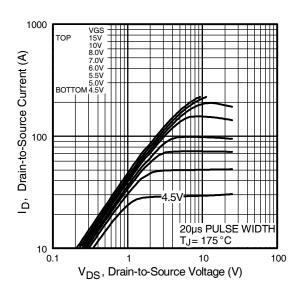
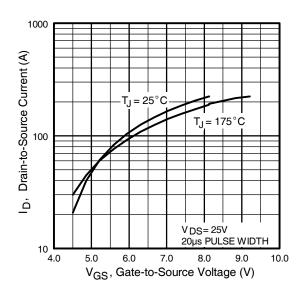


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



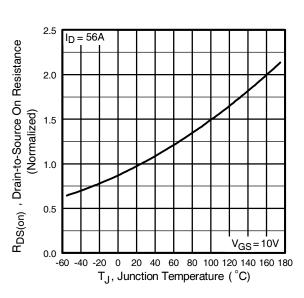
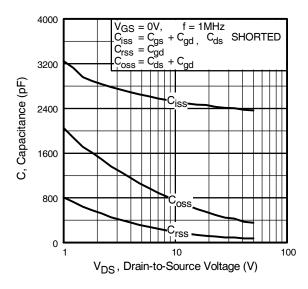


Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature



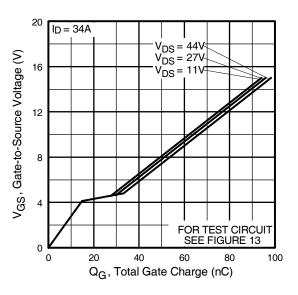
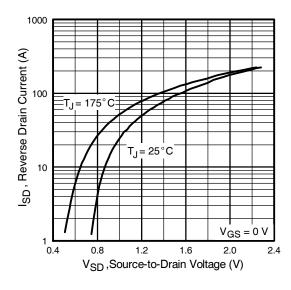


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage



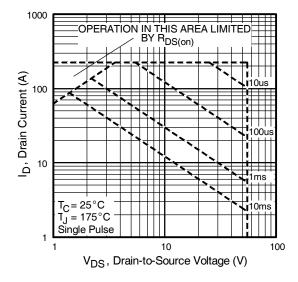


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

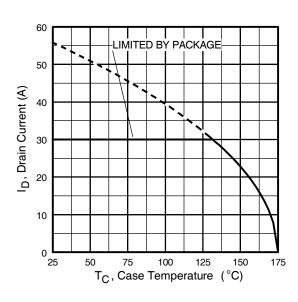


Fig 9. Maximum Drain Current Vs. Case Temperature

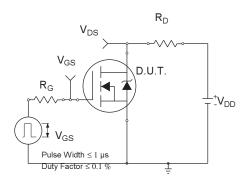


Fig 10a. Switching Time Test Circuit

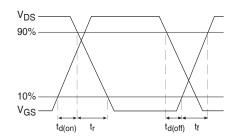


Fig 10b. Switching Time Waveforms

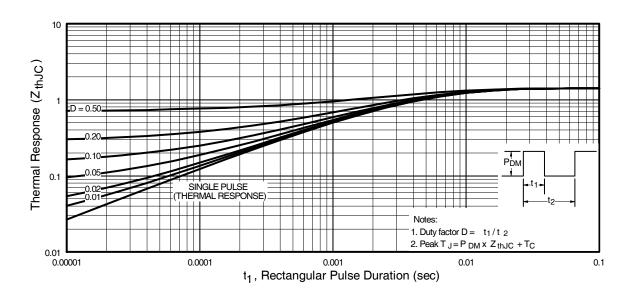


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

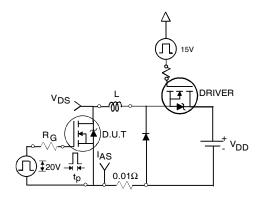


Fig 12a. Unclamped Inductive Test Circuit

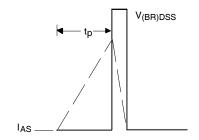


Fig 12b. Unclamped Inductive Waveforms

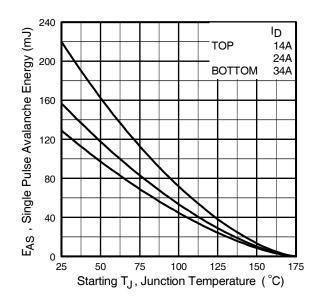


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

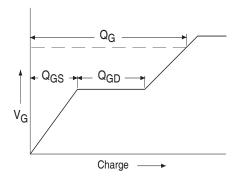


Fig 13a. Basic Gate Charge Waveform

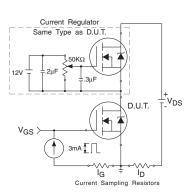
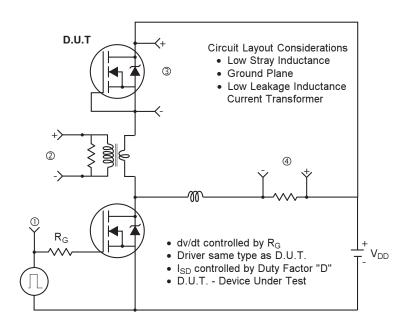


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



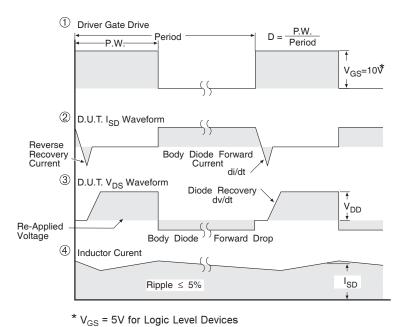
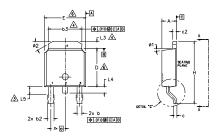


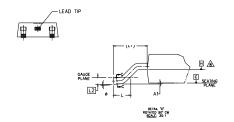
Fig 14. For N-Channel HEXFET® Power MOSFETs

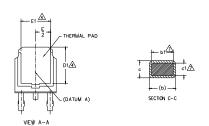
AUIRFR2405

D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)







- 1.- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS]
- A- LEAD DIMENSION UNCONTROLLED IN L5.
- A- DIMENSION D1, E1, L3 & b3 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- AND DIMENSION DT, ET, L3 & B5 ESTABLISH A MINIMUM MOUNTING SUPFACE FOR THERMAL PAD.

 SECTION OF THE LEAD BETWEEN .005 AND 0.10
 [0.13 AND 0.25] FROM THE LEAD TIP.

 AND DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED .005 [0.13] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.

 DIMENSION b1 & c1 APPLIED TO BASE METAL ONLY.
- A- DATUM A & B TO BE DETERMINED AT DATUM PLANE H
- 9,- OUTLINE CONFORMS TO JEDEC OUTLINE TO-252AA.

3;- OCIENC CONFORMS TO BEDEC OCIENC TO-2						
S		N				
M B O	MILLIM	ETERS	INCHES			
l c	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	2,18	2.39	.086	.094		
A1	-	0.13	-	.005		
ь	0,64	0.89	.025	.035		
ь1	0,65	0.79	.025	.031	7	
ь2	0.76	1,14	.030	.045		
ь3	4,95	5,46	.195	,215	4	
c	0.46	0.61	.018	.024		
c1	0.41	0.56	.016	.022	7	
c2	0.46	0.89	.018	.035		
D	5,97	6.22	.235	.245	6	
D1	5.21	-	.205	-	4	
Ε	6.35	6.73	.250	.265	6	
E1	4,32	-	.170	-	4	
e	2.29	BSC	.090	BSC		
н	9.40	10.41	.370	.410		
L	1.40	1.78	.055	.070		
L1	2,74	BSC	.108	REF,		
L2	0.51	BSC	.020	BSC		
L3	0.89	1.27	.035	.050	4	
L4	-	1.02	-	.040		
L5	1,14	1.52	.045	.060	3	
ø	0.	10*	0.	10*		
ø1	0.	15*	0,	15*		
ø2	25*	35°	25*	35°		
Ø2	25*	35*	25*	35*		

LEAD ASSIGNMENTS

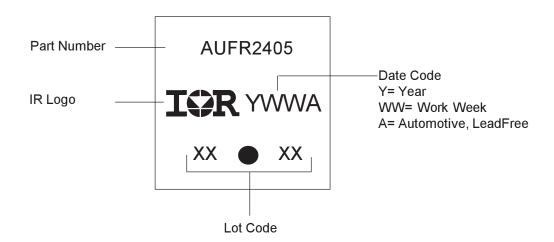
HEXFET

- 1.- GATE 2.- DRAIN
- 3.- SOURCE 4.- DRAIN

IGBT & CoPAK

- 1.- GATE 2.- COLLECTOR 3.- EMITTER 4.- COLLECTOR

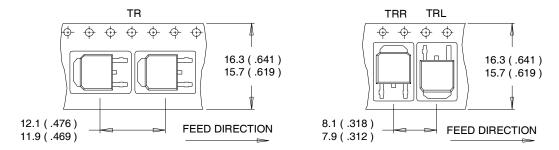
D-Pak Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

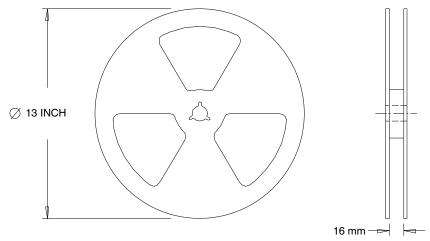
D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

1. OUTLINE CONFORMS TO EIA-481.

Ordering Information

Base part number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRFR2405	Dpak	Tube	75	AUIRFR2405
		Tape and Reel	2000	AUIRFR2405TR
		Tape and Reel Left	3000	AUIRFR2405TRL
		Tape and Reel Right	3000	AUIRFR2405TRR

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RJK60S3DPP-E0#T2 RJK60S5DPK-M0#T0 APT5010JVFR APT12031JFLL APT12040JVR DMN3404LQ-7 NTE6400 JANTX2N6796U JANTX2N6784U JANTXV2N5416U4 SQM110N05-06L-GE3 SIHF35N60E-GE3 2SK2614(TE16L1,Q)